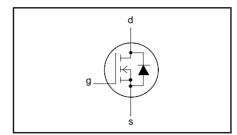
IRF540, IRF540S

FEATURES

- 'Trench' technology
- Low on-state resistance
- Fast switching
- Low thermal resistance

SYMBOL



QUICK REFERENCE DATA

$$V_{DSS} = 100 \text{ V}$$
 $I_D = 23 \text{ A}$
 $R_{DS(ON)} \le 77 \text{ m}\Omega$

GENERAL DESCRIPTION

N-channel enhancement mode field-effect power transistor in a plastic envelope using 'trench' technology.

Applications:-

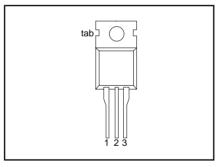
- d.c. to d.c. converters
- switched mode power supplies
- T.V. and computer monitor power supplies

The IRF540 is supplied in the SOT78 (TO220AB) conventional leaded package. The IRF540S is supplied in the SOT404 (D²PAK) surface mounting package.

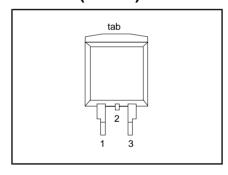
PINNING

PIN	DESCRIPTION	
1	gate	
2	drain ¹	
3	source	
tab	drain	

SOT78 (TO220AB)



SOT404 (D²PAK)



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Drain-source voltage	$T_i = 25 ^{\circ}\text{C} \text{ to } 175 ^{\circ}\text{C}$	-	100	V
Drain-gate voltage	$T_i = 25 ^{\circ}\text{C}$ to 175 $^{\circ}\text{C}$; $R_{GS} = 20 \text{k}\Omega$	-	100	V
Gate-source voltage	, ,	-	± 20	V
Continuous drain current	$T_{mb} = 25 ^{\circ}C; V_{GS} = 10 V$	-	23	Α
	$T_{mb} = 100 ^{\circ}C; V_{GS} = 10 V$	-	16	Α
Pulsed drain current	$T_{mb} = 25 ^{\circ}C$	-	92	Α
Total power dissipation		-	100	W
Operating junction and		- 55	175	°C
	Drain-source voltage Drain-gate voltage Gate-source voltage Continuous drain current Pulsed drain current Total power dissipation	$\begin{array}{lll} \text{Drain-source voltage} & \text{$T_j = 25\ ^{\circ}$C to $175\ ^{\circ}$C} \\ \text{Drain-gate voltage} & \text{$T_j = 25\ ^{\circ}$C to $175\ ^{\circ}$C}; \ R_{GS} = 20\ k\Omega \\ \text{Gate-source voltage} & \text{$T_{mb} = 25\ ^{\circ}$C}; \ V_{GS} = 10\ V \\ \text{$T_{mb} = 100\ ^{\circ}$C}; \ V_{GS} = 10\ V \\ \text{$T_{mb} = 25\ ^{\circ}$C} \\ \text{Total power dissipation} & \text{$T_{mb} = 25\ ^{\circ}$C} \\ \text{Operating junction and} & \text{$T_{mb} = 25\ ^{\circ}$C} \\ \end{array}$	$\begin{array}{llllllllllllllllllllllllllllllllllll$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

¹ It is not possible to make connection to pin:2 of the SOT404 package

IRF540, IRF540S

AVALANCHE ENERGY LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
E _{AS}	Non-repetitive avalanche energy	Unclamped inductive load, I_{AS} = 10 A; t_p = 350 μ s; T_j prior to avalanche = 25°C; $V_{DD} \le$ 25 V; R_{GS} = 50 Ω ; V_{GS} = 10 V; refer to fig:14		230	mJ
I _{AS}	Peak non-repetitive avalanche current	, and the second	-	23	Α

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{\text{th j-mb}}$	Thermal resistance junction to mounting base			-	1.5	K/W
R _{th j-a}	Thermal resistance junction to ambient	SOT78 package, in free air SOT404 package, pcb mounted, minimum footprint	1 1	60 50	-	K/W K/W

ELECTRICAL CHARACTERISTICS

T_i= 25°C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	Drain-source breakdown	$V_{GS} = 0 \text{ V}; I_D = 0.25 \text{ mA};$	100	-	-	< <
$V_{GS(TO)}$	voltage Gate threshold voltage	$T_{j} = -55^{\circ}C$ $V_{DS} = V_{GS}; I_{D} = 1 \text{ mA}$ $T_{c} = 175^{\circ}C$	89 2 1	3	4	V V V
R _{DS(ON)}	Drain-source on-state	$T_{j} = 175^{\circ}C$ $T_{j} = -55^{\circ}C$ $V_{GS} = 10 \text{ V}; I_{D} = 17 \text{ A}$	- -	- 49	6 77	${\sf V} \\ {\sf m} \Omega$
g _{fs} I _{GSS} I _{DSS}	resistance Forward transconductance Gate source leakage current Zero gate voltage drain current	$T_{j} = 175^{\circ}C$ $V_{DS} = 25 \text{ V}; I_{D} = 17 \text{ A}$ $V_{GS} = \pm 20 \text{ V}; V_{DS} = 0 \text{ V}$ $V_{DS} = 100 \text{ V}; V_{GS} = 0 \text{ V}$ $V_{DS} = 20 \text{ V}; V_{DS} = 0 \text{ V}$	8.7 - -	132 15.5 10 0.05	193 - 100 10 250	mΩ S nA μA
$\begin{matrix} Q_{g(tot)} \\ Q_{gs} \\ Q_{gd} \end{matrix}$	Total gate charge Gate-source charge Gate-drain (Miller) charge	$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 175^{\circ}\text{C}$ $I_D = 17 \text{ A}; V_{DD} = 80 \text{ V}; V_{GS} = 10 \text{ V}$	- - -	- - -	65 10 29	μΑ nC nC nC
$t_{d \text{ on}}$ t_{r} $t_{d \text{ off}}$ t_{f}	Turn-on delay time Turn-on rise time Turn-off delay time Turn-off fall time	V_{DD} = 50 V; R_{D} = 2.2 Ω; V_{GS} = 10 V; R_{G} = 5.6 Ω Resistive load	- - -	8 39 26 24	- - -	ns ns ns
L _d L _d	Internal drain inductance Internal drain inductance	Measured tab to centre of die Measured from drain lead to centre of die	-	3.5 4.5	-	nH nH
L _s	Internal source inductance	(SOT78 package only) Measured from source lead to source bond pad	-	7.5	-	nΗ
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Feedback capacitance	V _{GS} = 0 V; V _{DS} = 25 V; f = 1 MHz	- - -	890 139 83	1187 167 109	pF pF pF

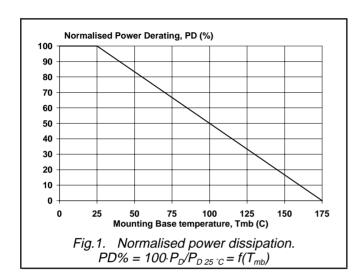
IRF540, IRF540S

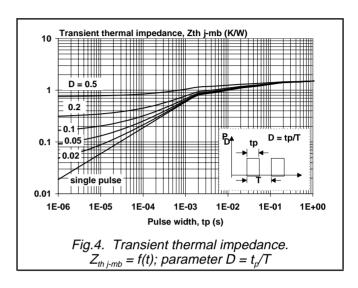
REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS

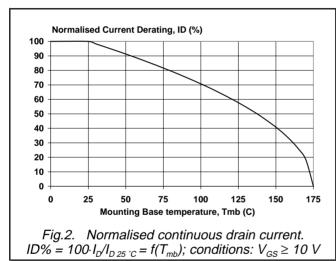
T_i = 25°C unless otherwise specified

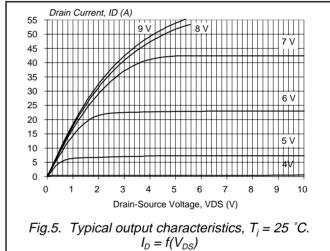
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Is	Continuous source current (body diode)		-	-	23	Α
I _{SM}	Pulsed source current (body diode)		-	-	92	Α
V_{SD}	Diode forward voltage	$I_F = 28 \text{ A}; V_{GS} = 0 \text{ V}$	1	0.94	1.5	V
t _{rr} Q _{rr}	Reverse recovery time Reverse recovery charge	$I_F = 17 \text{ A}; -dI_F/dt = 100 \text{ A}/\mu\text{s};$ $V_{GS} = 0 \text{ V}; V_R = 25 \text{ V}$	1 1	61 200	-	ns nC

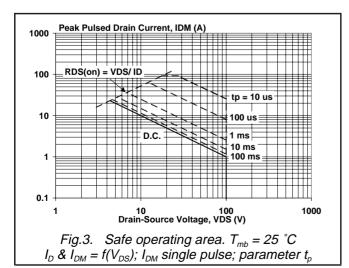
IRF540, IRF540S

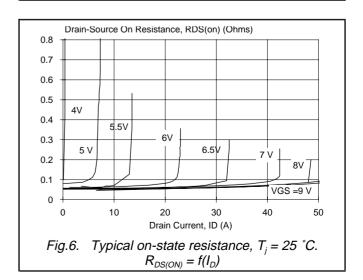




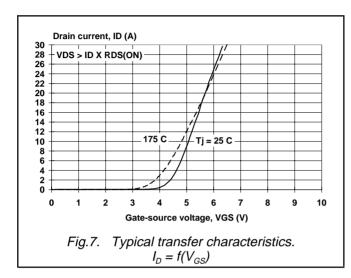


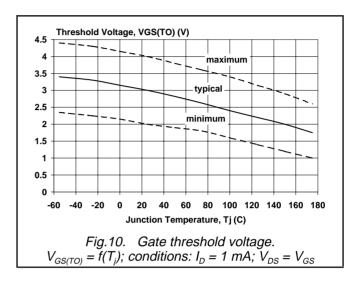


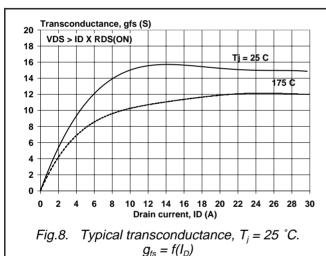


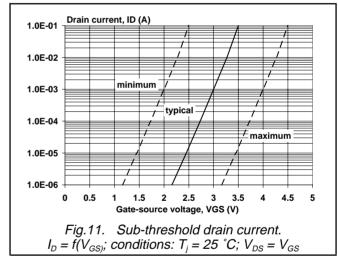


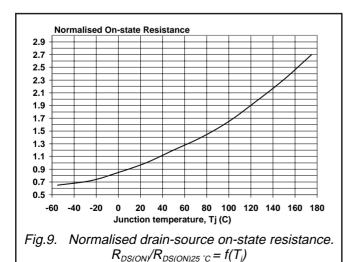
IRF540, IRF540S

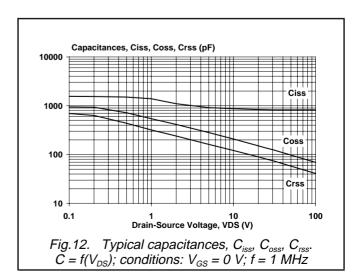








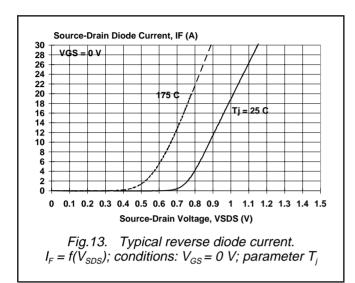




Philips Semiconductors Product specification

N-channel TrenchMOSTM transistor

IRF540, IRF540S



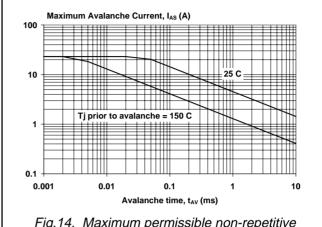
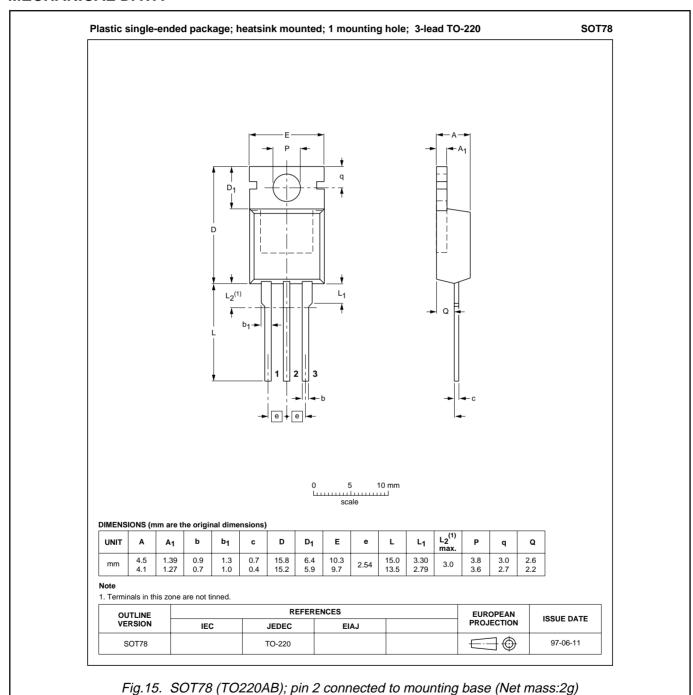


Fig.14. Maximum permissible non-repetitive avalanche current (I_{AS}) versus avalanche time (t_{AV}); unclamped inductive load

IRF540, IRF540S

MECHANICAL DATA

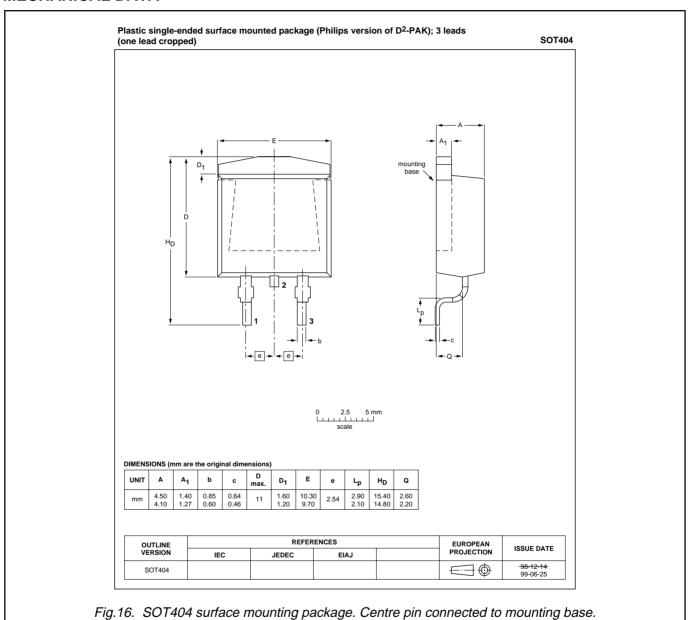


Notes

- 1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
- 2. Refer to mounting instructions for SOT78 (TO220AB) package.
- 3. Epoxy meets UL94 V0 at 1/8".

IRF540, IRF540S

MECHANICAL DATA

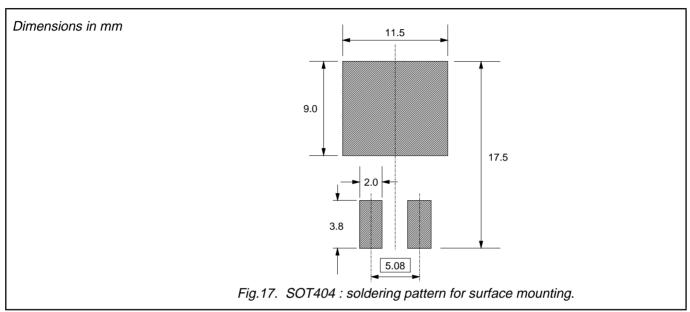


Notes

- 1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
- 2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
- 3. Epoxy meets UL94 V0 at 1/8".

IRF540, IRF540S

MOUNTING INSTRUCTIONS



DEFINITIONS

Data sheet status				
Objective specification	This data sheet contains target or goal specifications for product development.			
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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